



(Fwd) Receipt

PATENT
29936/39889

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Sang Kyun Park

I hereby certify that this paper and the
documents referred to as enclosed
therewith are being deposited with the
United States Postal Service as first class
mail, postage prepaid, on **May 24, 2004**,
in an envelope addressed to
Commissioner for Patents, P.O. Box
1450, Alexandria, Virginia 22313-1450

Serial No.: 10/749,022

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Filed: December 30, 2003

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For: Method of Forming Copper
Wiring in Semiconductor Device

)

Group Art Unit: 2812

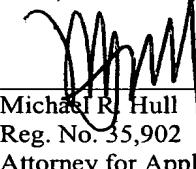
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Examiner: To be assigned

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Michael R. Hull
Reg. No. 35,902
Attorney for Applicant

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Applicant requests the issuance of a corrected filing receipt. A copy of the official filing receipt issued by the U.S. Patent and Trademark Office is enclosed with the following corrections noted in red: the inventor's city of residence should be Kyungki-do, not "Yongin-shi."

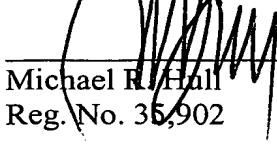
Accordingly, applicant respectfully requests the issuance of a corrected filing receipt in connection with this application.

Respectfully submitted,

MARSHALL, GERSTEIN & BORUN LLP
6300 Sears Tower
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May 24, 2004

By:


Michael R. Hull
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MAY 27 2004
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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/749,022	12/30/2003	2812	860	29936/39889	4	25	2

CONFIRMATION NO. 9225

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MARSHALL, GERSTEIN & BORUN LLP
6300 SEARS TOWER
233 S. WACKER DRIVE
CHICAGO, IL 60606

FILING RECEIPT

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OC000000012476476*

MAY 04 2004

MARSHALL GERSTEIN

Date Mailed: 04/29/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Sang Kyun Park, Yongin-Shi, KOREA, REPUBLIC OF;

Domestic Priority data as claimed by applicant

Foreign Applications

REPUBLIC OF KOREA 2003-46292 07/09/2003
REPUBLIC OF KOREA 2003-46291 07/09/2003

If Required, Foreign Filing License Granted: 04/28/2004

Projected Publication Date: 01/13/2005

Non-Publication Request: No

Early Publication Request: No

Title

Method of forming copper wiring in semiconductor device

Preliminary Class

**LICENSE FOR FOREIGN FILING UNDER
Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**

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